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(21) Application number: **04107275**(22) Date of filing: **27.04.92**(71) Applicant: **NIPPON TELEGR & TELEPH
CORP <NTT>**(72) Inventor: **TSUNETSUGU HIDEKI
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KATSURA KOSUKE****(54) ELECTROOPTIC MODULE AND MANUFACTURE
THEREOF****(57) Abstract:**

PURPOSE: To mount an electrooptic element or component on a board with high workability without requiring fine adjusting mechanism for alignment.

CONSTITUTION: Recesses 12a to be fitted with electrooptic elements 11 are made in a mounting board 12 by means of anisotropic chemical etching. Electrooptic elements 11 are then fitted in the recesses 12a while being aligned and they are bonded each other through an adhesive 13 thus producing an electrooptic module.

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